

# plerow<sup>™</sup> ALN1810AT

#### **Internally Matched LNA Module**

#### **Features**

- · S<sub>21</sub> = 15.7 dB @ 1750 MHz
  - = 14.9 dB @ 1870 MHz
- · NF of 0.65 dB over Frequency
- · Unconditionally Stable
- · Single 5V Supply
- · High OIP3 @ Low Current

Parameter

**Frequency Range** 

Gain Flatness

Noise Figure

Output IP3<sup>(1)</sup>

S11 / S22 (2)

Output P1dB

Switching Time

Supply Current

Supply Voltage

Impedance

Gain

**Specifications (in Production)** 

#### Description

Unit

MHz

dB

dB

dB

dBm

dB

dBm

μsec

mΑ

V

Ω

dBm

mm

The plerow<sup>™</sup> ALN-series is the compactly designed surface-mount module for the use of the LNA with or without the following gain blocks in the infrastructure equipment of the mobile wireless (CDMA, GSM, PCS, PHS, WCDMA, DMB, WLAN, WiBro, WiMAX), GPS, satellite communication terminals, CATV and so on. It has an exceptional performance of low noise figure, high gain, high OIP3, and low bias current. The stability factor is always kept more than unity over the application band in order to ensure its unconditionally stable implementation to the application system environment. The surface-mount module package including the completed matching circuit and other components necessary just in case allows very simple and convenient implementation onto the system board in mass production level.

Typ. @ T = 25°C,  $V_s$  = 5 V, Freq. = 1810 MHz,  $Z_{o.sys}$  = 50 ohm

Min

1750

14.3

33

17

Specifications

Typ

15.3

± 0.4

0.65

34

18

\_

65

5

50

C.W 29 ~ 31 (before fail)

Surface Mount Type, 10Wx10Lx3.8H

Max

1870

± 0.6

0.7

-19 / -9

75







1-stage Single Type

#### More Information

Website: www.asb.co.kr E-mail: sales@asb.co.kr

Tel: (82) 42-528-7223 Fax: (82) 42-528-7222

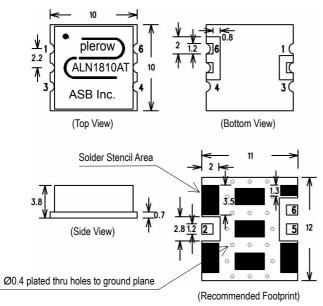
ASB Inc., 4th FI. Venture Town Bldg., 367-17 Goijeong-Dong, Seo-Gu, Daejon 302-716, Korea

Package Type & Size Operating temperature is -40°C to +85°C.

Max. RF Input Power

1) OIP3 is measured with two toes at an output power of 4 dBm / tone separated by 1 MHz.
2) S11/S22 (max) is the worst value within the frequency band.
3) Switching time means the time that takes for output power to get stabilized to its final level after switching DC voltage from 0 V to V<sub>S</sub>.

## **Outline Drawing (Unit: mm)**



Pin Number	Function
2	RF In
5	RF Out
6	+Vcc
Others	Ground

Note: 1. The number and size of ground via holes in a circuit board is critical for thermal RF grounding considerations.

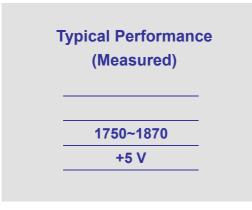
2. We recommend that the ground via holes be placed on the bottom of all ground pins for better RF and thermal performance, as shown in the drawing at the left side.

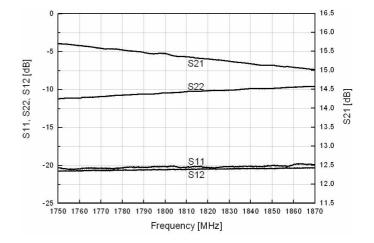


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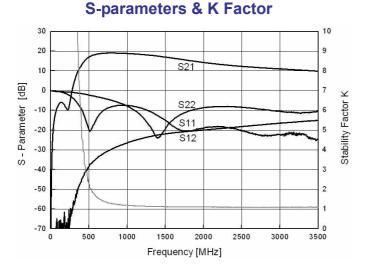
#### Internally Matched LNA Module

S-parameters

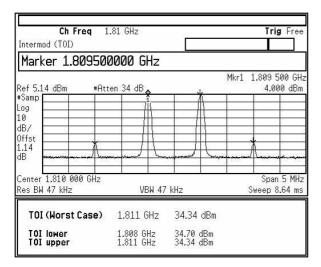




## Noise Figure

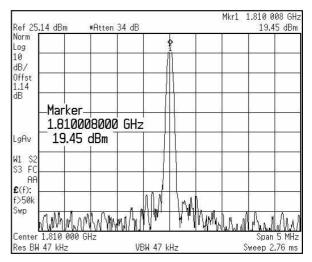


OIP3



Mkr1 Mkr2 Mkr3 1.75 GHz 1.81 GHz 1.87 GHz 0.601 dB 0.612 dB 11 854 dB 16.097 dB 15.416 dB 15.332 dB 9.00 NFIG Scale 1.00 df -1.00 40.0 GAIN Scale 5.000 dE -10.00 Center 1.81000 GHz BW 4 MHz Span 150.00 MHz Loss On Corr oints Att 0/-- dB Tcold 308.56 K Avgs 5

#### P1dB



November 2008



ltem Voltage	S11 (dB)	S22 (dB)	S21 (dB)	G/F (dB)	NF (dB)	P1dB (dBm)	OIP3 (dBm)	Current (mA)
4.5	-20.4	-12.3	15.1	0.35	0.601	19.4	34.6	59
4.6	-20.6	-12.2	15.1	0.35	0.602	19.4	34.6	61
4.7	-20.9	-12.1	15.1	0.34	0.604	19.4	34.6	63
4.8	-21.2	-12.0	15.1	0.34	0.606	19.4	34.6	65
4.9	-21.3	-11.9	15.1	0.33	0.608	19.4	34.5	68
5.0	-21.5	-11.7	15.1	0.33	0.612	19.4	34.4	70
5.1	-21.8	-11.6	15.1	0.32	0.613	19.4	34.5	72
5.2	-22.0	-11.5	15.2	0.32	0.615	19.4	34.5	74
5.3	-22.2	-11.3	15.2	0.31	0.617	19.4	34.5	76
5.4	-22.5	-11.2	15.2	0.31	0.618	19.4	34.5	78
5.5	-22.6	-11.0	15.2	0.30	0.619	19.4	34.5	80

## **RF Performance with Voltage Change**

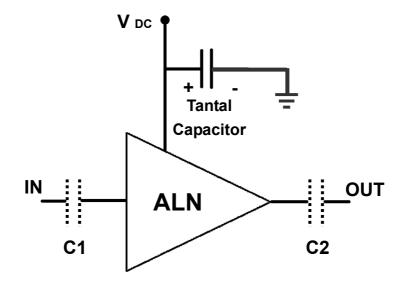
## **RF Performance with Operating Temperature**

ltem Temp.	S11 (dB)	S22 (dB)	S21 (dB)	G/F (dB)	NF (dB)	P1dB (dBm)	OIP3 (dBm)	Current (mA)
- 40°C	-25.0	-10.3	16.2	0.27	0.362	19.9	33.4	68
- 20°C	-23.5	-10.9	16.0	0.29	0.423	19.8	34.5	69
0°C	-22.7	-11.6	15.9	0.31	0.492	19.7	35.3	69
25°C	-21.7	-11.5	15.7	0.33	0.612	19.4	34.4	70
40°C	-21.2	-11.5	15.6	0.33	0.697	19.3	32.7	69
60°C	-20.9	-11.4	15.5	0.33	0.794	19.1	32.6	69
80°C	-19.3	-11.1	15.3	0.33	0.883	18.9	32.5	68
100°C	-19.1	-11.0	15.2	0.34	0.960	18.6	32.9	66



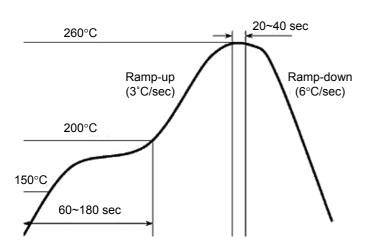
Internally Matched LNA Module

#### **Application Circuit**

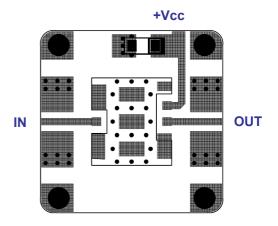


- The tantal capacitor is optional and for bypassing the AC noise introduced from the DC supply. The capacitance value may be determined by customer's DC supply status.
- 2) So-called DC blocking capacitors are always necessarily placed at the input and output port for allowing only the RF signal to pass and blocking the DC component in the signal. The DC blocking capacitors are included inside the LNA module. Therefore, C1 & C2 capacitors may not be necessary, but can be added just in case that the customer wants. The value of C1 & C2 is determined by considering the application frequency.

#### **Recommended Soldering Reflow Process**



#### **Evaluation Board Layout**



Size 25 x 25mm (for ALN-AT, BT, T Series – 10x10mm)

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